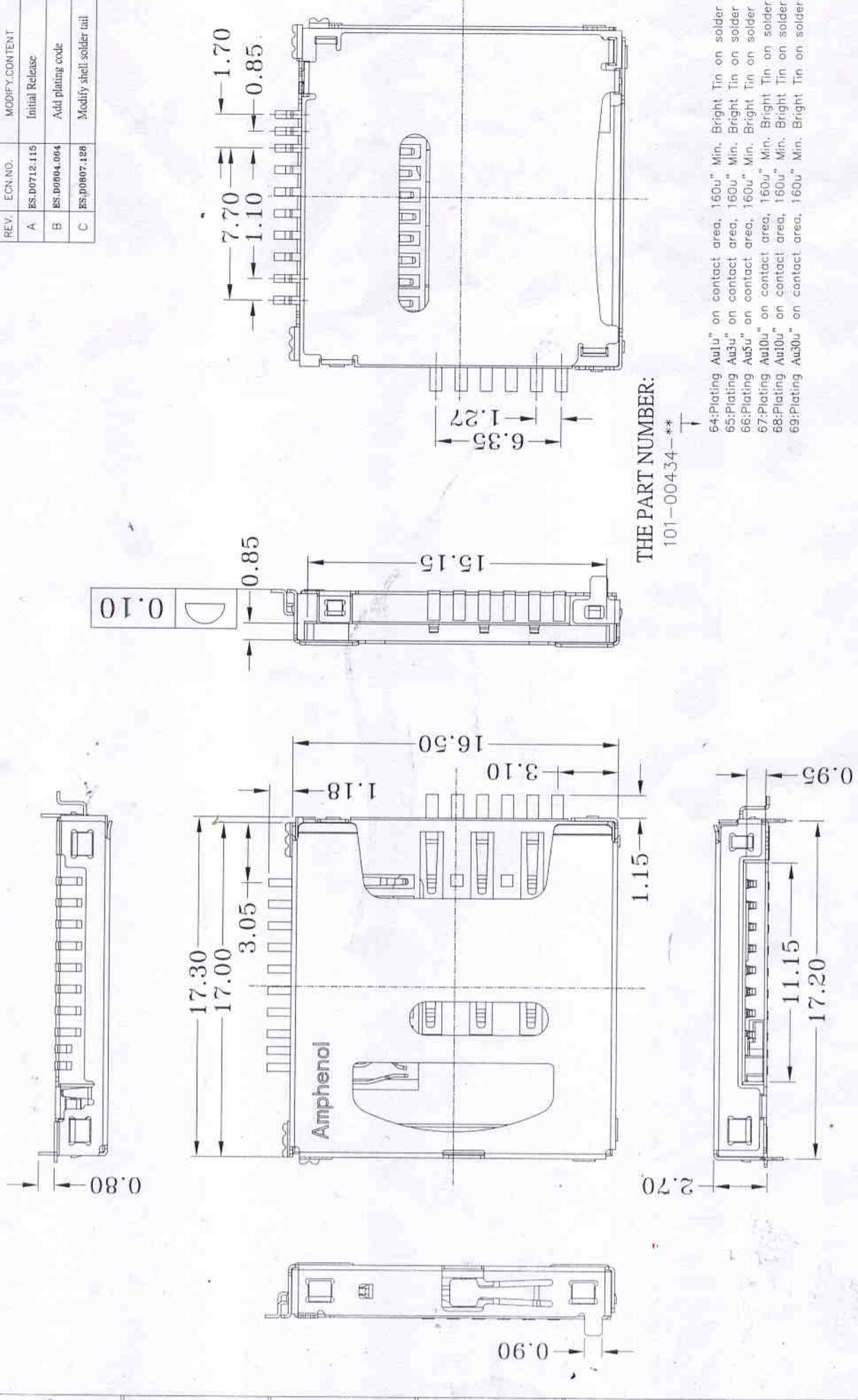


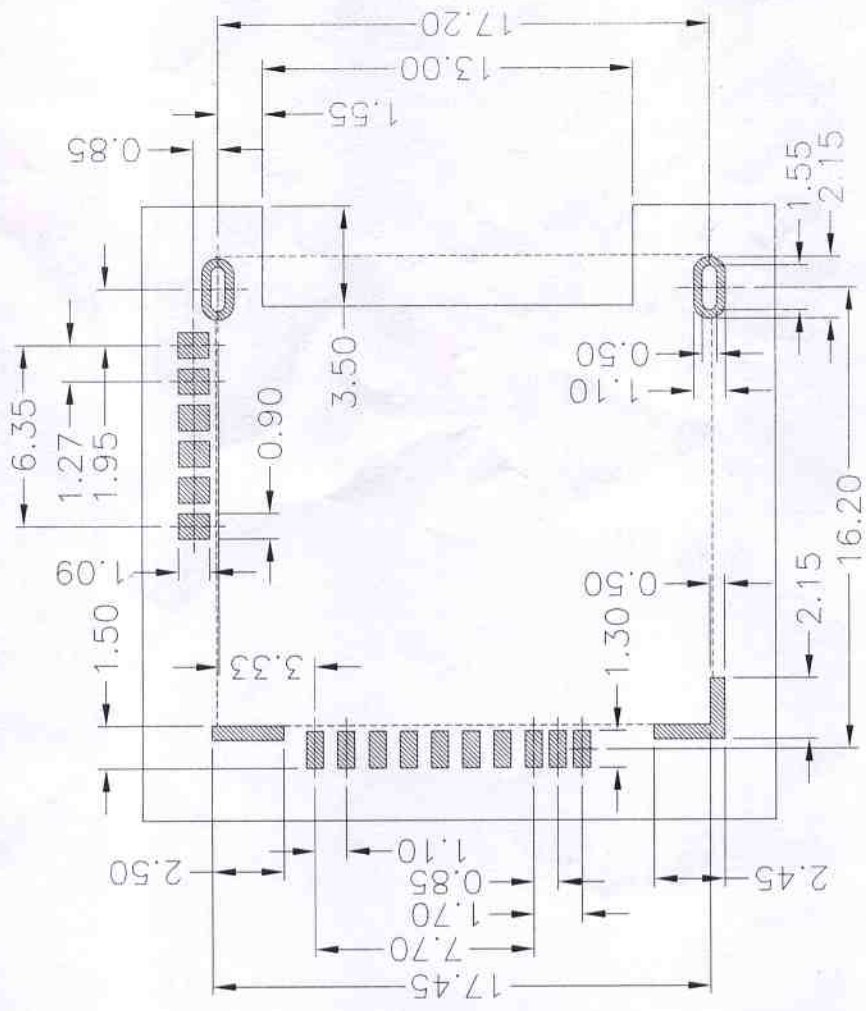
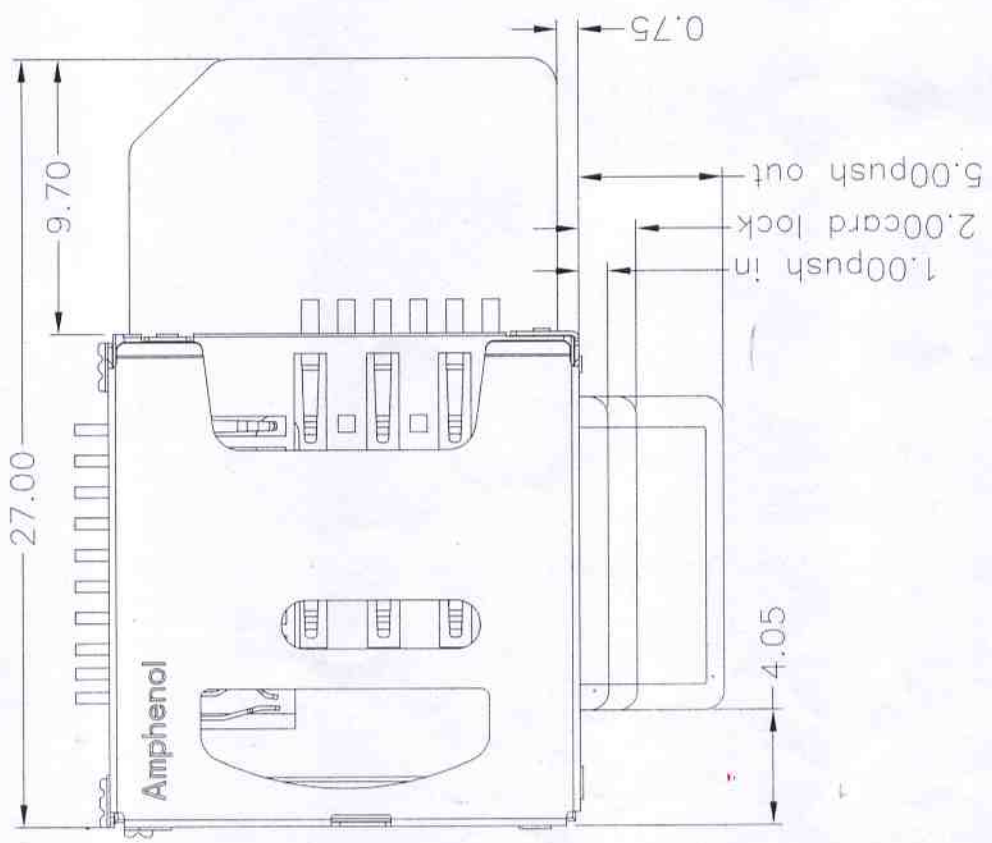
REV.	ECN NO.	MODIFY CONTENT	DATE
A	BS.D00712.115	Initial Release	2007/12/25
B	BS.D0004.064	Add plating code	2008/1/14
C	BS.D0807.129	Modify shell solder tail	2008/07/24



THE PART NUMBER:
101-00434-**-**

GENERAL TOLERANCE	FILE NO.	PART NO.	10100434**	DRAWN	MATERIAL	SCALE
X: ±0.50	REV.	TITLE	10100434**	CHECKED	DATE	1:1
.X: ±0.38	SIZE	SHEET	SIM+Micro-SD P/P CARD CONN.	APPROVED	2008/07/24	UNITS
.XX: ±0.25	A4	1 OF 3				MM
Amphenol Shouhmin Industry						

REV.	ECN NO.	MODIFY CONTENT	DATE
A	ES:00712.115	Initial Release	2007/12/25
B	ES:00804.64	Add plating code	2008/1/14
C	ES:00807.128	Modify shell solder tail	2008/07/24



PCB LAYOUT

GENERAL	TOLERANCE	FILE NO.	10100434	PART NO.	10100434**	DRAWN	Paul	MATERIAL	SCALE	1:1
X, ±0.50	X, ± 5°	REV.	C	TITLE	SIM+Micro-SD P/P CARD CONN.	CHECKED		DATE	UNITS	MM
X ±0.58	X ± 2°	SIZE		SHEET	2 OF 3	APPROVED		2008/07/24		
XX ±0.25	.XX ± 1°	A4								
Amphenol Shouhmin Industry										

